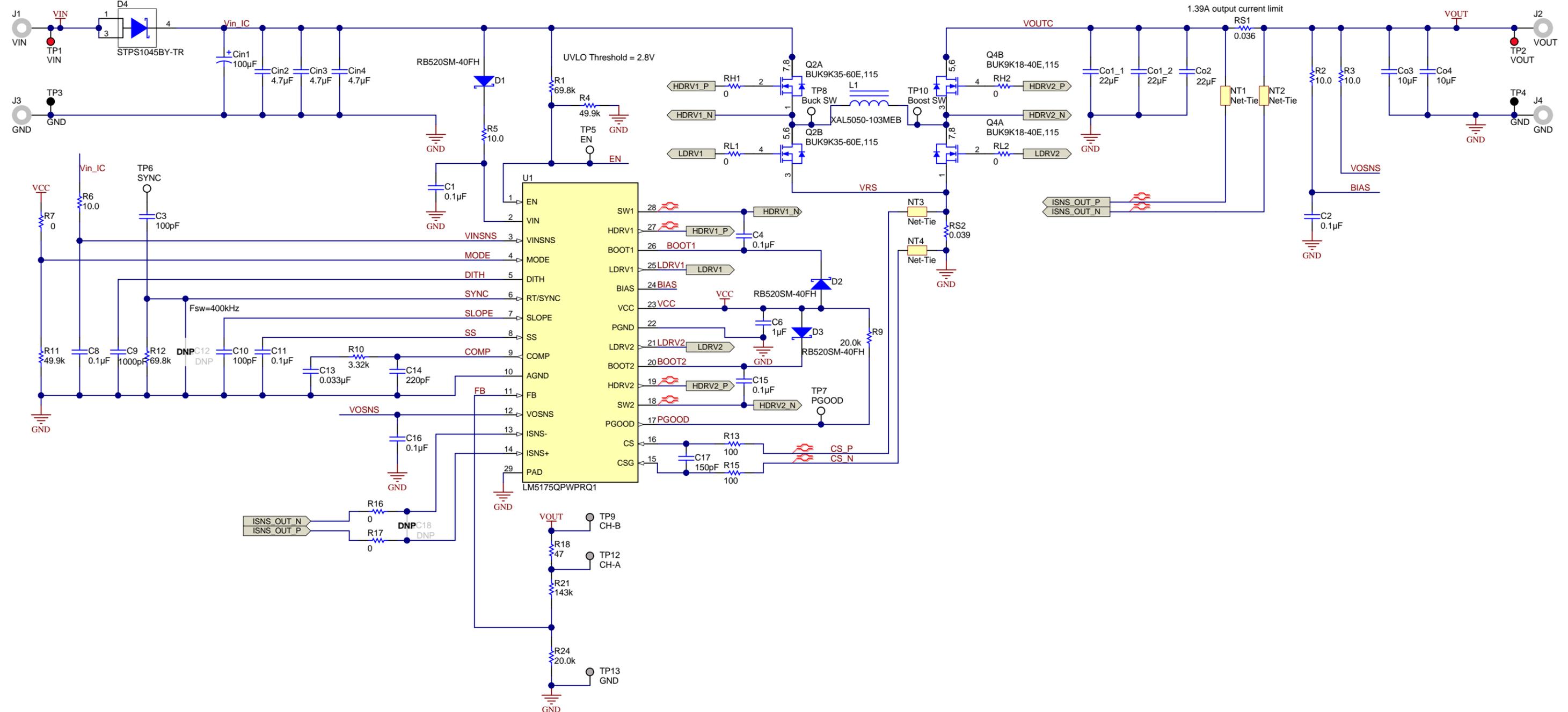


3.5V to 24V Input, 36V Maximum

6.5V Output @ 1.2A

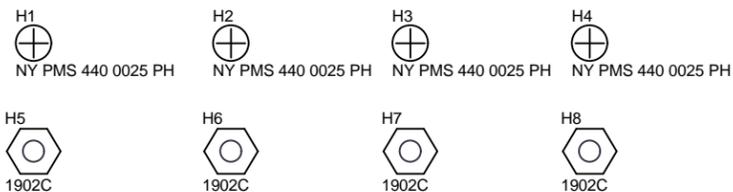


| | | |
|-----------------------------------|--|----------------------|
| Orderable: N/A | Designed for: Public Release | Mod. Date: 7/13/2016 |
| TID #: PMP10708 | Project Title: LM5175 Buck Boost | |
| Number: PMP10708 | Rev: A | Sheet Title: |
| SVN Rev: Version control disabled | Assembly Variant: 001 | Sheet: 1 of 2 |
| Drawn By: | File: PMP10708_LM5175_Buck-Boost.SchDoc | Size: B |
| Engineer: Xinyu Dai | Contact: http://www.ti.com/support | |

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PCB Number: PMP10708
 PCB Rev: A

PCB
 LOGO
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| Label Table | |
|-------------|------------|
| Variant | Label Text |
| 001 | |
| | |
| | |
| | |
| | |
| | |
| | |

ZZ2
Assembly Note
 These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
 These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

| | | |
|-----------------------------------|--|----------------------|
| Orderable: N/A | Designed for: Public Release | Mod. Date: 6/17/2015 |
| TID #: PMP10708 | Project Title: LM5175 Buck Boost | |
| Number: PMP10708 | Rev: A | Sheet Title: |
| SVN Rev: Version control disabled | Assembly Variant: 001 | Sheet: 2 of 2 |
| Drawn By: | File: PMP10708_Hardware.SchDoc | Size: B |
| Engineer: Xinyu Dai | Contact: http://www.ti.com/support | |

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